8-bit dual supply translating transceiver; 3-state Rev. 2 — 11 February 2011 Pro

Product data sheet

General description 1.

The 74LVC8T245; 74LVCH8T245 are 8-bit dual supply translating transceivers with 3-state outputs that enable bidirectional level translation. They feature two data input-output ports (pins An and Bn), a direction control input (DIR), an output enable input (OE) and dual supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied at any voltage between 1.2 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins An, OE and DIR are referenced to V_{CC(A)} and pins Bn are referenced to V_{CC(B)}. A HIGH on DIR allows transmission from An to Bn and a LOW on DIR allows transmission from Bn to An. The output enable input (OE) can be used to disable the outputs so the buses are effectively isolated.

The devices are fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either $V_{CC(A)}$ or $V_{CC(B)}$ are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH8T245 holds unused or floating data inputs at a valid logic level.

2. Features and benefits

- Wide supply voltage range:
 - V_{CC(A)}: 1.2 V to 5.5 V
 - V_{CC(B)}: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Maximum data rates:
 - 420 Mbps (3.3 V to 5.0 V translation)
 - 210 Mbps (translate to 3.3 V))
 - 140 Mbps (translate to 2.5 V)
 - 75 Mbps (translate to 1.8 V)



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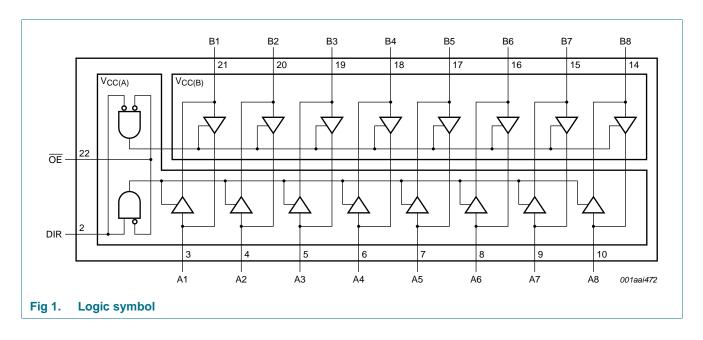
- ◆ 60 Mbps (translate to 1.5 V)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78B Class II
- ± 24 mA output drive (V_{CC} = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 30 μA maximum I_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

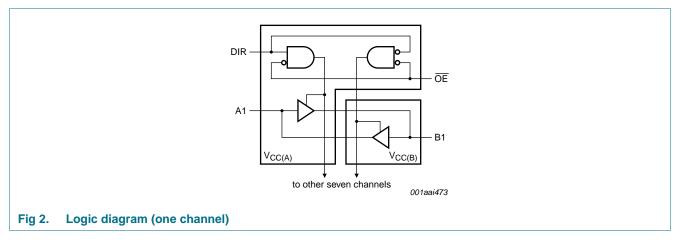
Type number	Package							
	Temperature range	Name	Description	Version				
74LVC8T245PW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads;	SOT355-1				
74LVCH8T245PW			body width 4.4 mm					
74LVC8T245BQ	–40 °C to +125 °C	DHVQFN24	······································	SOT815-1				
74LVCH8T245BQ			thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm					

4. Functional diagram

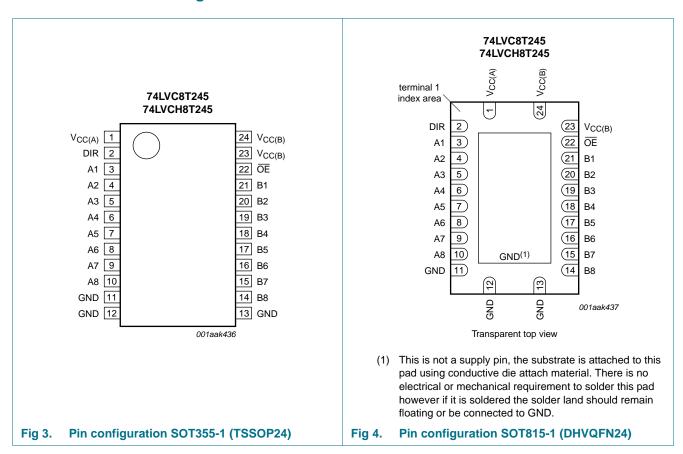


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5. Pinning information



5.1 Pinning

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5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
V _{CC(A)}	1	supply voltage A (An inputs/outputs, $\overline{\text{OE}}$ and DIR inputs are referenced to $V_{\text{CC}(A)})$
DIR	2	direction control
A1 to A8	3, 4, 5, 6, 7, 8, 9, 10	data input or output
GND ^[1]	11	ground (0 V)
GND ^[1]	12	ground (0 V)
GND ^[1]	13	ground (0 V)
B1 to B8	21, 20, 19, 18, 17, 16, 15, 14	data input or output
OE	22	output enable input (active LOW)
V _{CC(B)}	23	supply voltage B (Bn inputs/outputs are referenced to $V_{\mbox{CC}(\mbox{B})}$
V _{CC(B)}	24	supply voltage B (Bn inputs/outputs are referenced to $V_{\mbox{CC}(\mbox{B})}$

[1] All GND pins must be connected to ground (0 V).

6. Functional description

Table 3. Function table^[1]

Supply voltage	Input	Input Ir		
V _{CC(A)} , V _{CC(B)}	OE ^[2]	DIR ^[2]	An ^[2]	Bn ^[2]
1.2 V to 5.5 V	L	L	An = Bn	input
1.2 V to 5.5 V	L	Н	input	Bn = An
1.2 V to 5.5 V	Н	Х	Z	Z
GND ^[3]	Х	Х	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The An inputs/outputs, DIR and \overline{OE} input circuit is referenced to $V_{CC(A)}$; The Bn inputs/outputs circuit is referenced to $V_{CC(B)}$.

[3] If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC(A)}	supply voltage A		-0.5	+6.5	V
V _{CC(B)}	supply voltage B		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
I _O	output current	$V_{O} = 0 V$ to V_{CCO}	[2] _	±50	mA
I _{CC}	supply current	$I_{CC(A)} \text{ or } I_{CC(B)}; \text{ per } V_{CC} \text{ pin}$	-	100	mA

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Table 4. Limiting values ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					-
Symbol	Parameter	Conditions	Min	Max	Unit
I _{GND}	ground current	per GND pin	-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[4]</u> _	500	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

 V_{CCO} + 0.5 V should not exceed 6.5 V. [3]

[4] For TSSOP24 package: Ptot derates linearly at 5.5 mW/K above 60 °C. For DHVQFN24 package: Ptot derates linearly at 4.5 mW/K above 60 °C.

Recommended operating conditions 8.

Table 5. **Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	5.5	V
V _{CC(B)}	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{CCO}	V
		Suspend or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CCI} = 1.2 V	[2] _	20	ns/V
		$V_{CCI} = 1.4 \text{ V}$ to 1.95 V	-	20	ns/V
		V_{CCI} = 2.3 V to 2.7 V	-	20	ns/V
		$V_{CCI} = 3 V \text{ to } 3.6 V$	-	10	ns/V
		V_{CCI} = 4.5 V to 5.5 V	-	5	ns/V

V_{CCO} is the supply voltage associated with the output port. [1]

[2] V_{CCI} is the supply voltage associated with the input port.

Static characteristics 9.

Typical static characteristics at T_{amb} = 25 °C Table 6.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OH} HIGH-level output voltage		$V_{I} = V_{IH} \text{ or } V_{IL}$	<u>[1]</u>			
		$I_0 = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	-	1.09	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> _	0.07	-	V
l _l	input leakage current	DIR, \overline{OE} input; V _I = 0 V to 5.5 V; V _{CCI} = 1.2 V to 5.5 V	[2] _	-	±1	μΑ
I _{BHL}	bus hold LOW current	A or B port; $V_I = 0.42$ V; $V_{CCI} = 1.2$ V	[2] _	19	-	μΑ
I _{BHH}	bus hold HIGH current	A or B port; V_I = 0.78 V; V_{CCI} = 1.2 V	[2] _	–19	-	μΑ

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At recom	mended operating conditions	s; voltages are referenced to GND (ground = 0 V).					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{BHLO}	bus hold LOW overdrive current	A or B port; $V_{CCI} = 1.2 V$	<u>[2][3]</u>	-	19	-	μΑ
I _{BHHO}	bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 V$	<u>[2][3]</u>	-	-19	-	μΑ
I _{OZ}	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u>	-	-	±1	μΑ
		suspend mode A port; V _O = 0 V or V _{CCO} ; V _{CC(A)} = 5.5 V; V _{CC(B)} = 0 V	<u>[1]</u>	-	-	±1	μΑ
		suspend mode B port; V _O = 0 V or V _{CCO} ; V _{CC(A)} = 0 V; V _{CC(B)} = 5.5 V	<u>[1]</u>	-	-	±1	μΑ
I _{OFF}	power-off leakage current	A port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V		-	-	±1	μΑ
		B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	-	±1	μΑ
CI	input capacitance	DIR, \overline{OE} input; V _I = 0 V or 3.3 V; V _{CC(A)} = 3.3 V		-	3	-	pF
C _{I/O}	input/output capacitance	A and B port; V _O = 3.3 V or 0 V; V _{CC(A)} = V _{CC(B)} = 3.3 V		-	6.5	-	pF

Typical static characteristics at T_{amb} = 25 °C ... continued Table 6.

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] To guarantee the node switches, an external driver must source/sink at least IBHLO / IBHHO when the input is in the range VIL to VIH.

Table 7. **Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		−40 °C to	+85 °C	–40 °C to +125 °C		Unit
				Min	Max	Min	Мах	
V_{IH}	HIGH-level	data input	<u>[1]</u>					
input voltage	V _{CCI} = 1.2 V		0.8V _{CCI}	-	0.8V _{CCI}	-	V	
		$V_{CCI} = 1.4 \text{ V}$ to 1.95 V		$0.65V_{CCI}$	-	0.65V _{CCI}	-	V
	V_{CCI} = 2.3 V to 2.7 V		1.7	-	1.7	-	V	
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		0.7V _{CCI}	-	0.7V _{CCI}	-	V
		DIR, OE input						
		V _{CCI} = 1.2 V		0.8V _{CC(A)}	-	0.8V _{CC(A)}	-	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		0.65V _{CC(A)}	-	0.65V _{CC(A)}	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.7	-	1.7	-	V
	$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V	
		V_{CCI} = 4.5 V to 5.5 V		0.7V _{CC(A)}	-	0.7V _{CC(A)}	-	V

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Symbol	Parameter	Conditions		−40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
V _{IL}	LOW-level	data input	<u>[1]</u>					
	input voltage	V _{CCI} = 1.2 V		-	0.2V _{CCI}	-	0.2V _{CCI}	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		-	0.35V _{CCI}	-	$0.35V_{CCI}$	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V to } 3.6 \text{ V}$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CCI}	-	0.3V _{CCI}	V
		DIR, OE input						
		V _{CCI} = 1.2 V		-	0.2V _{CC(A)}	-	0.2V _{CC(A)}	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V to } 3.6 \text{ V}$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CC(A)}	-	0.3V _{CC(A)}	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH}$						
		I _O = -100 μA; V _{CCO} = 1.2 V to 4.5 V	[2]	$V_{CCO}-0.1$	-	$V_{CCO}-0.1$	-	V
		$I_{O} = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		1.2	-	1.2	-	V
		$I_0 = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		1.9	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		2.4	-	2.4	-	V
		$I_{O} = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		3.8	-	3.8	-	V
V _{OL}	LOW-level	$V_{I} = V_{IL}$	[2]					
	output voltage	I _O = 100 μA; V _{CCO} = 1.2 V to 4.5 V		-	0.1	-	0.1	V
		$I_0 = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		I_{O} = 12 mA; V_{CCO} = 2.3 V		-	0.3	-	0.3	V
		$I_{O} = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I _I	input leakage current	DIR, \overline{OE} input; V _I = 0 V to 5.5 V; V _{CCI} = 1.2 V to 5.5 V		-	±2	-	±10	μΑ
I _{BHL}	bus hold LOW	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.49 \text{ V}; V_{CCI} = 1.4 \text{ V}$		15	-	10	-	μΑ
		V _I = 0.58 V; V _{CCI} = 1.65 V		25	-	20	-	μΑ
		$V_{I} = 0.70 \text{ V}; V_{CCI} = 2.3 \text{ V}$		45	-	45	-	μΑ
		V _I = 0.80 V; V _{CCI} = 3.0 V		100	-	80	-	μA
		V _I = 1.35 V; V _{CCI} = 4.5 V		100	-	100	-	μA

Table 7. Static characteristics ... continued

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Symbol	Parameter	Conditions		−40 °C to	o +85 °C	-40 °C to	• +125 °C	Unit
				Min	Max	Min	Max	
I _{ВНН}	bus hold HIGH	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.91 \text{ V}; V_{CCI} = 1.4 \text{ V}$		-15	-	-10	-	μΑ
		V _I = 1.07 V; V _{CCI} = 1.65 V		-25	-	-20	-	μA
		V _I = 1.70 V; V _{CCI} = 2.3 V		-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μA
		V _I = 3.15 V; V _{CCI} = 4.5 V		-100	-	-100	-	μA
BHLO	bus hold LOW	A or B port	<u>[1][3]</u>					
	overdrive	V _{CCI} = 1.6 V		125	-	125	-	μA
Ĺ	current	V _{CCI} = 1.95 V		200	-	200	-	μA
		$V_{CCI} = 2.7 V$		300	-	300	-	μA
		V _{CCI} = 3.6 V		500	-	500	-	μA
		$V_{CCI} = 5.5 V$		900	-	900	-	μA
BHHO bus	bus hold HIGH overdrive	A or B port	[1][3]					
		V _{CCI} = 1.6 V		-125	-	-125	-	μA
	current	V _{CCI} = 1.95 V		-200	-	-200	-	μA
		$V_{CCI} = 2.7 V$		-300	-	-300	-	μA
		V _{CCI} = 3.6 V		-500	-	-500	-	μA
		$V_{CCI} = 5.5 V$		-900	-	-900	-	μA
I _{OZ}	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	[2]	-	±2	-	±10	μA
		suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 5.5 V;$ $V_{CC(B)} = 0 V$	[2]	-	±2	-	±10	μA
		suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 5.5 V$	[2]	-	±2	-	±10	μA
OFF	power-off leakage current	A port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V		-	±2	-	±10	μΑ
	current	B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	±2	-	±10	μΑ

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Symbol	Parameter	Conditions		–40 °C t	to +85 °C	–40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
I _{CC}	supply current	A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A	[1]					
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	15	-	20	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	15	-	20	μΑ
		$V_{CC(A)} = 0 V; V_{CC(B)} = 5.5 V$		-2	-	-4	-	μΑ
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A						
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	15	-	20	μΑ
		$V_{CC(B)} = 0 V; V_{CC(A)} = 5.5 V$		-2	-	-4	-	μΑ
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	15	-	20	μΑ
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_0 = 0$ A; $V_I = 0$ V or V_{CCI}						
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	25	-	30	μA
ΔI_{CC}	additional supply current	per input; $V_{CC(A)}$, $V_{CC(B)}$ = 3.0 V to 5.5 V						
		DIR and \overline{OE} input; DIR or \overline{OE} input at $V_{CC(A)} - 0.6 V$; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μA
		A port; A port at $V_{CC(A)} - 0.6$ V; DIR at $V_{CC(A)}$; B port = open	<u>[4]</u>	-	50	-	75	μA
		B port; B port at $V_{CC(B)} - 0.6 V$; DIR at GND; A port = open	<u>[4]</u>	-	50	-	75	μA

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO} / I_{BHHO} when the input is in the range V_{IL} to V_{IH}.

[4] For non bus hold parts only (74LVC8T245).

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10. Dynamic characteristics

Table 8. Typical dynamic characteristics at $V_{CC(A)} = 1.2$ V and $T_{amb} = 25 \ ^{\circ}C_{C}^{[1]}$

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for waveforms see Figure 5 and Figure 6.

Symbol	Parameter	Conditions			Vco	С(В)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{pd}	propagation delay	An to Bn	11.0	8.5	7.4	6.2	5.7	5.4	ns
		Bn to An	11.0	10.0	9.5	9.1	8.9	8.9	ns
t _{dis}	disable time	OE to An	9.5	9.5	9.5	9.5	9.5	9.5	ns
		OE to Bn	10.2	8.2	7.8	6.7	7.3	6.4	ns
t _{en}	enable time	OE to An	13.5	13.5	13.5	13.5	13.5	13.5	ns
		OE to Bn	13.6	10.3	8.9	7.5	7.1	7.0	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

Table 9. Typical dynamic characteristics at $V_{CC(B)} = 1.2$ V and $T_{amb} = 25 \ ^{\circ}C^{[1]}$

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for waveforms see Figure 5 and Figure 6.

Symbol	Parameter	Conditions			Vcc	C(A)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{pd}	propagation delay	An to Bn	11.0	10.0	9.5	9.1	8.9	8.8	ns
		Bn to An	11.0	8.5	7.3	6.2	5.7	5.4	ns
t _{dis}	disable time	OE to An	9.5	6.8	5.4	3.8	4.1	3.1	ns
		OE to Bn	10.2	9.1	8.6	8.1	7.8	7.8	ns
t _{en}	enable time	OE to An	13.5	9.0	6.9	4.8	3.8	3.2	ns
		OE to Bn	13.6	12.5	12.0	11.5	11.4	11.4	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

Table 10. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \ ^{\circ}C_{L1[2]}^{[1]}$ Voltages are referenced to GND (ground = 0 V).

Symbol	bol Parameter Conditions		V _{CC(A)} and V _{CC(B)}					
			1.8 V	2.5 V	3.3 V	5.0 V		
C_{PD}	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	1	1	1	2	pF	
		A port: (direction B to A); B port: (direction A to B)	13	13	13	13	pF	

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

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Symbol	Parameter	Conditions					Vcc	C(B)					Uni
			1.5 V	± 0.1 V	1.8 V ±	0.15 V	2.5 V	± 0.2 V	3.3 V :	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.5 V \pm 0.1 V	1	l										
t _{pd}	propagation	An to Bn	1.7	27	1.7	23	1.3	18	1.0	15	0.8	13	ns
	delay	Bn to An	0.9	27	0.9	25	0.8	23	0.7	23	0.7	22	ns
t _{dis}	disable time	OE to An	1.5	30	1.5	30	1.5	30	1.5	30	1.4	30	ns
		OE to Bn	2.4	34	2.4	33	1.9	15	1.7	14	1.3	12	ns
t _{en}	enable time	OE to An	0.4	34	0.4	34	0.4	34	0.4	34	0.4	34	ns
		OE to Bn	1.8	36	1.8	34	1.5	18	1.2	15	0.9	13	ns
V _{CC(A)} =	$\textbf{1.8 V} \pm \textbf{0.15 V}$												
t _{pd}	propagation	An to Bn	1.7	25	1.7	21.9	1.3	9.2	1.0	7.4	0.8	7.1	ns
	delay	Bn to An	0.9	23	0.9	23.8	0.8	23.6	0.7	23.4	0.7	23.4	ns
t _{dis}	disable time	OE to An	1.5	30	1.5	29.6	1.5	29.4	1.5	29.3	1.4	29.2	ns
		OE to Bn	2.4	33	2.4	32.2	1.9	13.1	1.7	12.0	1.3	10.3	ns
t _{en}	enable time	OE to An	0.4	24	0.4	24.0	0.4	23.8	0.4	23.7	0.4	23.7	ns
		OE to Bn	1.8	34	1.8	32.0	1.5	16.0	1.2	12.6	0.9	10.8	ns
V _{CC(A)} =	$\textbf{2.5 V} \pm \textbf{0.2 V}$												
t _{pd}	propagation	An to Bn	1.5	23	1.5	21.4	1.2	9.0	0.8	6.2	0.6	4.8	ns
	delay	Bn to An	1.2	18	1.2	9.3	1.0	9.1	1.0	8.9	0.9	8.8	ns
t _{dis}	disable time	OE to An	1.4	9.0	1.4	9.0	1.4	9.0	1.4	9.0	1.4	9.0	ns
		OE to Bn	2.3	31	2.3	29.6	1.8	11.0	1.7	9.3	0.9	6.9	ns
t _{en}	enable time	OE to An	1.0	10.9	1.0	10.9	1.0	10.9	1.0	10.9	1.0	10.9	ns
		OE to Bn	1.7	32	1.7	28.2	1.5	12.9	1.2	9.4	1.0	6.9	ns
V _{CC(A)} =	3.3 V \pm 0.3 V												
t _{pd}	propagation	An to Bn	1.5	23	1.5	21.2	1.1	8.8	0.8	6.3	0.5	4.4	ns
	delay	Bn to An	0.8	15	0.8	7.2	0.8	6.2	0.7	6.1	0.6	6.0	ns
t _{dis}	disable time	OE to An	1.6	8.2	1.6	8.2	1.6	8.2	1.6	8.2	1.6	8.2	ns
		OE to Bn	2.1	30	2.1	29.0	1.7	10.3	1.5	8.6	0.8	6.3	ns
t _{en}	enable time	OE to An	0.8	8.1	0.8	8.1	0.8	8.1	0.8	8.1	0.8	8.1	ns
		OE to Bn	1.8	31	1.8	27.7	1.4	12.4	1.1	8.5	0.9	6.4	ns
$V_{CC(A)} =$	5.0 V \pm 0.5 V												
t _{pd}	propagation	An to Bn	1.5	22	1.5	21.4	1.0	8.8	0.7	6.0	0.4	4.2	ns
	delay	Bn to An	0.7	13	0.7	7.0	0.4	4.8	0.3	4.5	0.3	4.3	ns
t _{dis}	disable time	OE to An	0.3	5.4	0.3	5.4	0.3	5.4	0.3	5.4	0.3	5.4	ns
		OE to Bn	2.0	30	2.0	28.7	1.6	9.7	1.4	8.0	0.7	5.7	ns
t _{en}	enable time	OE to An	0.7	6.4	0.7	6.4	0.7	6.4	0.7	6.4	0.7	6.4	ns
	enable time	OE to Bn	1.5	31	1.5	27.6	1.3	11.4	1.0	8.1	0.9	6.0	ns

Table 11. Dynamic characteristics for temperature range $-40 \,^{\circ}\text{C}$ to $+85 \,^{\circ}\text{C}^{[1]}$

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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Symbol	Parameter	Conditions		V _{CC(B)}								Uni	
			1.5 V	± 0.1 V	1.8 V ±	0.15 V	1	± 0.2 V	3.3 V :	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
$V_{CC(A)} =$	1.5 V \pm 0.1 V												
t _{pd}	propagation	An to Bn	1.7	32	1.7	27	1.3	21	1.0	18	0.8	16	ns
	delay	Bn to An	0.9	32	0.9	30	0.8	28	0.7	28	0.7	26	ns
t _{dis}	disable time	OE to An	1.5	34	1.5	34	1.5	34	1.5	34	1.4	34	ns
		OE to Bn	2.4	41	2.4	40	1.9	18	1.7	17	1.3	15	ns
t _{en}	enable time	OE to An	0.4	40	0.4	40	0.4	40	0.4	40	0.4	40	ns
		OE to Bn	1.8	43	1.8	41	1.5	22	1.2	18	0.9	16	ns
V _{CC(A)} =	$\textbf{1.8 V} \pm \textbf{0.15 V}$												
t _{pd}	propagation	An to Bn	1.7	30	1.7	25.9	1.3	13.2	1.0	11.4	0.8	11.1	ns
	delay	Bn to An	0.9	27	0.9	28.8	0.8	27.6	0.7	27.4	0.7	27.4	ns
t _{dis}	disable time	OE to An	1.5	34	1.5	33.6	1.5	33.4	1.5	33.3	1.4	33.2	ns
		OE to Bn	2.4	40	2.4	36.2	1.9	17.1	1.7	16.0	1.3	14.3	ns
t _{en}	enable time	OE to An	0.4	28	0.4	28	0.4	27.8	0.4	27.7	0.4	27.7	ns
		OE to Bn	1.8	41	1.8	40	1.5	20	1.2	16.6	0.9	14.8	ns
$V_{CC(A)} =$	$\textbf{2.5 V} \pm \textbf{0.2 V}$												
t _{pd}	propagation	An to Bn	1.5	28	1.5	25.4	1.2	13	0.8	10.2	0.6	8.8	ns
	delay	Bn to An	1.2	23	1.2	13.3	1.0	13.1	1.0	12.9	0.9	12.8	ns
t _{dis}	disable time	OE to An	1.4	13	1.4	13	1.4	13	1.4	13	1.4	13	ns
		OE to Bn	2.3	37	2.3	33.6	1.8	15	1.7	14.3	0.9	10.9	ns
t _{en}	enable time	OE to An	1.0	17.2	1.0	17.2	1.0	17.3	1.0	17.2	1.0	17.3	ns
		OE to Bn	1.7	38	1.7	32.2	1.5	18.1	1.2	14.1	1.0	11.2	ns
$V_{CC(A)} =$	3.3 V \pm 0.3 V												
t _{pd}	propagation	An to Bn	1.5	28	1.5	25.2	1.1	12.8	0.8	10.3	0.5	10.4	ns
	delay	Bn to An	0.8	18	0.8	11.2	0.8	10.2	0.7	10.1	0.6	10	ns
t _{dis}	disable time	OE to An	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	ns
		OE to Bn	2.1	36	2.1	33	1.7	14.3	1.5	12.6	0.8	10.3	ns
t _{en}	enable time	OE to An	0.8	14.1	0.8	14.1	0.8	13.6	0.8	13.2	0.8	13.6	ns
		OE to Bn	1.8	37	1.8	31.7	1.4	18.4	1.1	12.9	0.9	10.9	ns
V _{CC(A)} =	5.0 V \pm 0.5 V												
t _{pd}	propagation	An to Bn	1.5	26	1.5	25.4	1.0	12.8	0.7	10	0.4	8.2	ns
	delay	Bn to An	0.7	16	0.7	11	0.4	8.8	0.3	8.5	0.3	8.3	ns
t _{dis}	disable time	OE to An	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	ns
		OE to Bn	2.0	36	2.0	32.7	1.6	13.7	1.4	12	0.7	9.7	ns
t _{en}	enable time	OE to An	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	ns
		OE to Bn	1.5	37	1.5	31.6	1.3	18.4	1.0	13.7	0.9	10.7	ns

Table 12. Dynamic characteristics for temperature range $-40 \text{ °C to } +125 \text{ °C}^{[1]}$ Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for wave forms see Figure 5 and Figure 5.

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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11. Waveforms

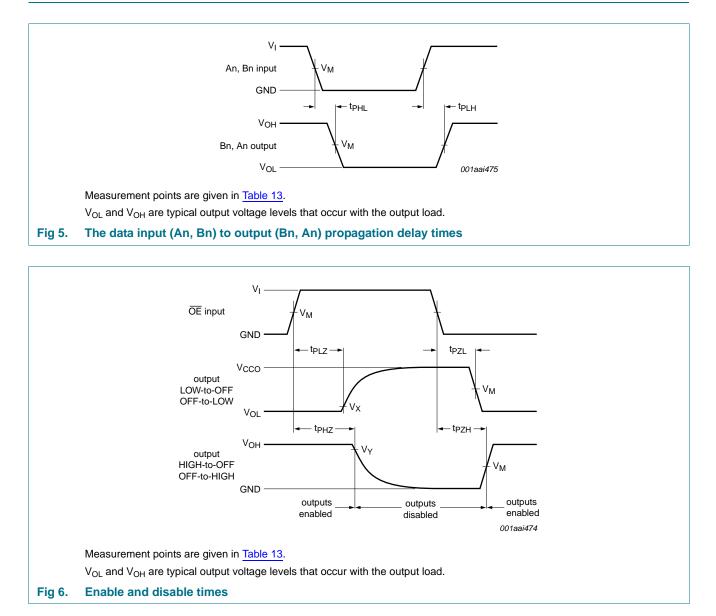


Table 13. Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
V _{CC(A)} , V _{CC(B)}	V _M	V _M	V _X	V _Y
1.2 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 5.5 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.3 V	V _{OH} – 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

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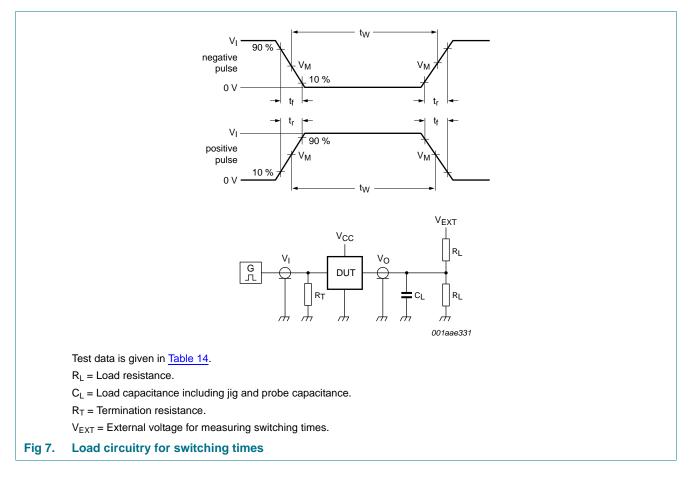


Table 14. Test data

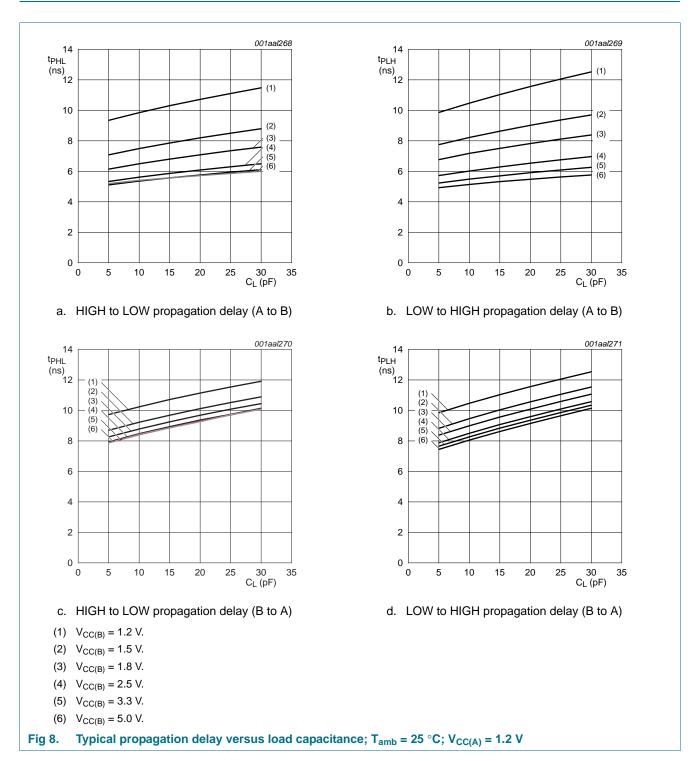
Supply voltage	Input		Load		V _{EXT}			
V _{CC(A)} , V _{CC(B)}	V _I [1]	∆ t/∆V[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]	
1.2 V to 5.5 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}	

[1] V_{CCI} is the supply voltage associated with the data input port.

 $\label{eq:constraint} [2] \quad dV/dt \geq 1.0 \ V/ns.$

[3] V_{CCO} is the supply voltage associated with the output port.

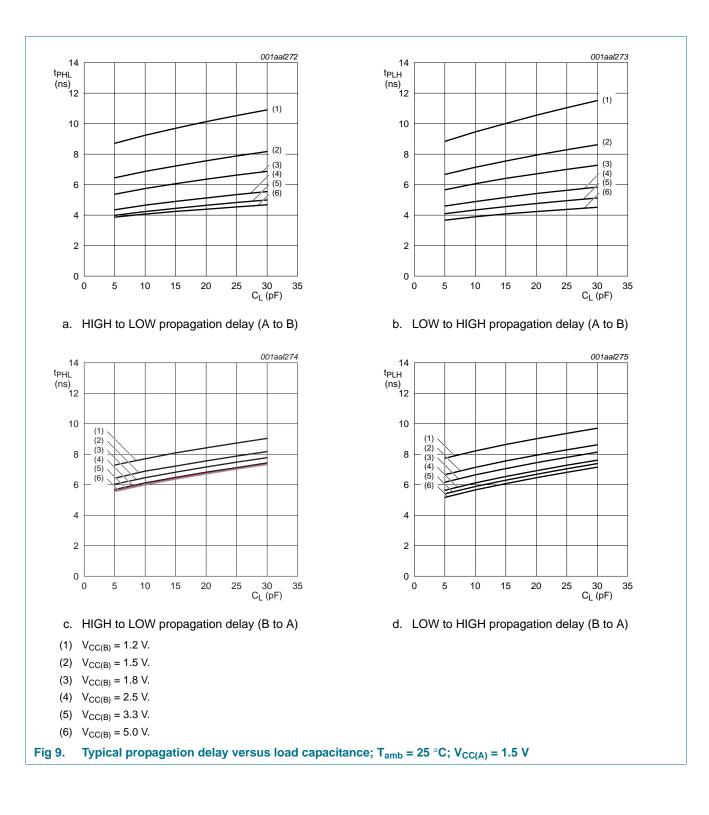
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12. Typical propagation delay characteristics

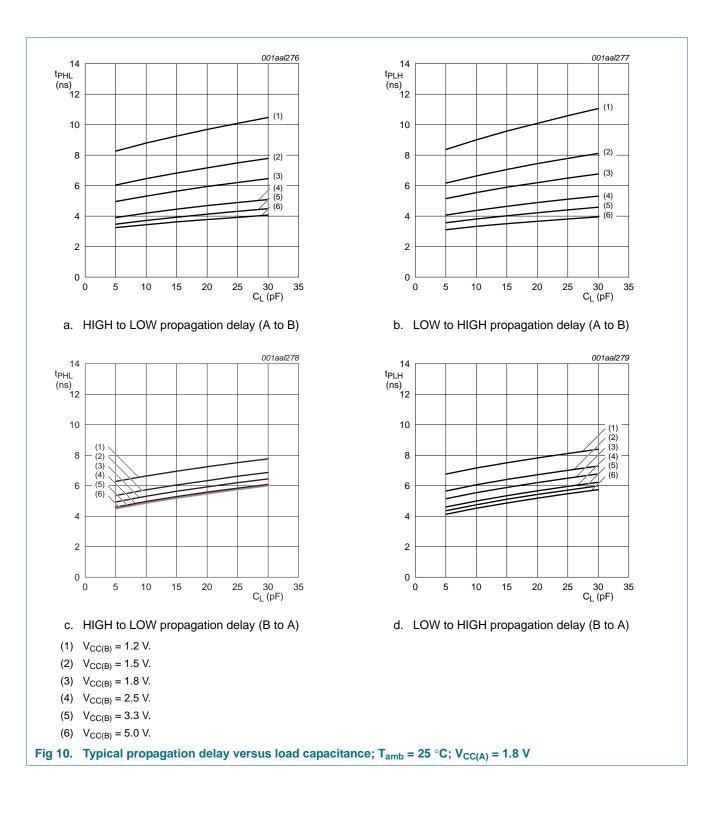
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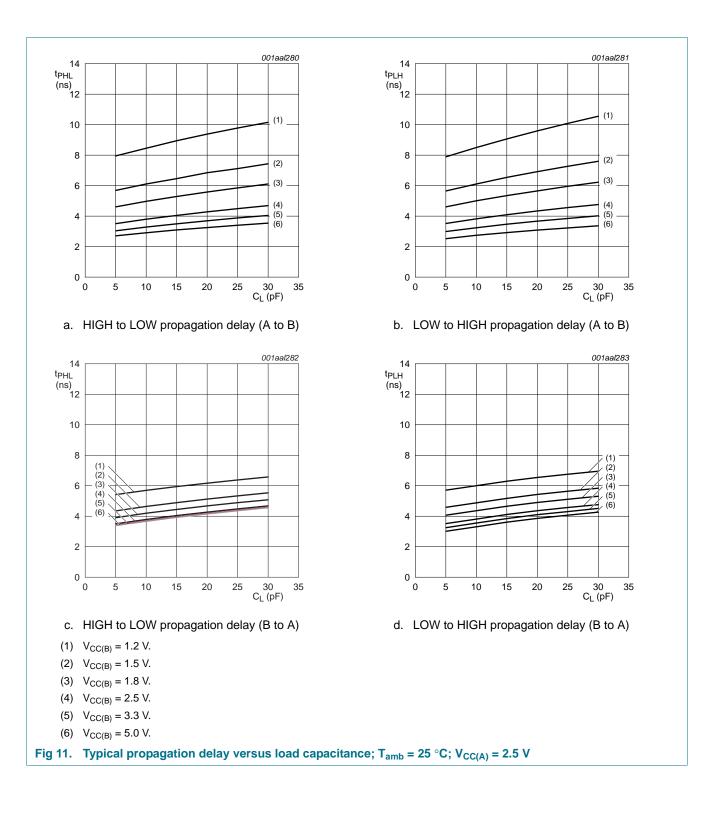
74LVC8T245; 74LVCH8T245

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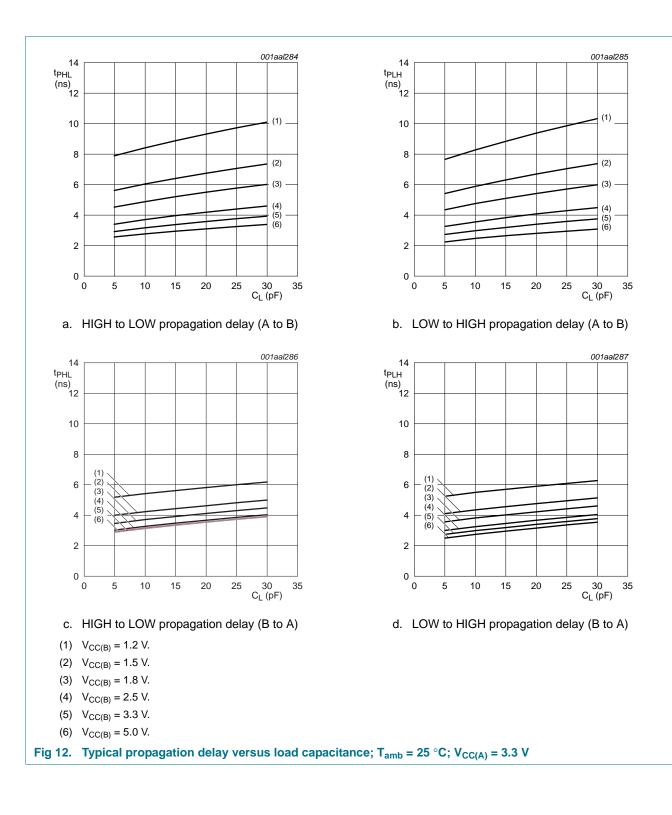
74LVC8T245; 74LVCH8T245

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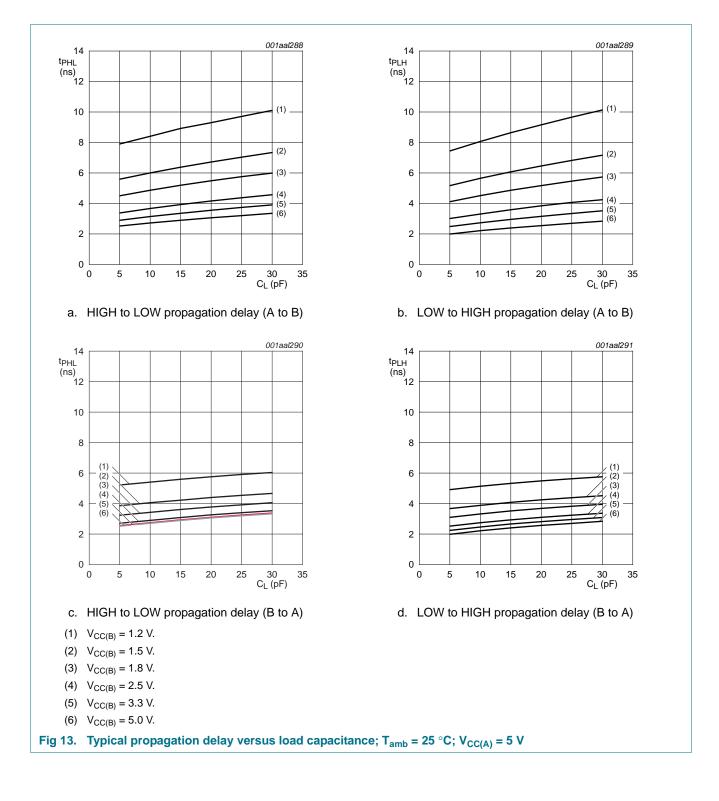
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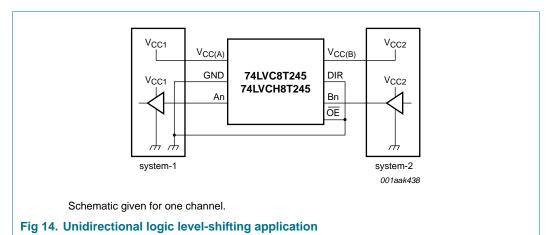


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13. Application information

13.1 Unidirectional logic level-shifting application

The circuit given in Figure 14 is an example of the 74LVC8T245; 74LVCH8T245 being used in an unidirectional logic level-shifting application.



Name Function Description supply voltage of system-1 (1.2 V to 5.5 V) V_{CC(A)} V_{CC1} GND GND device GND output level depends on V_{CC1} voltage A OUT В IN input threshold value depends on V_{CC2} voltage DIR DIR the GND (LOW level) determines B port to A port direction

supply voltage of system-2 (1.2 V to 5.5 V)

The GND (LOW level) enables the output ports

Table 15. Description unidirectional logic level-shifting application

V_{CC2}

OE

V_{CC(B)}

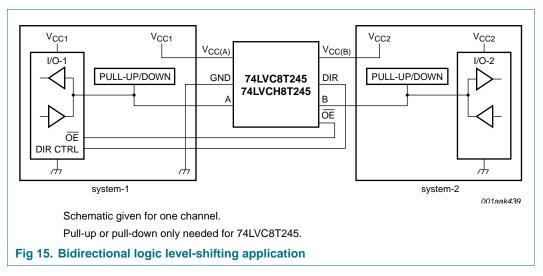
OE

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13.2 Bidirectional logic level-shifting application

<u>Figure 15</u> shows the 74LVC8T245; 74LVCH8T245 being used in a bidirectional logic level-shifting application.



<u>Table 16</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

State	DIR CTRL	OE	I/O-1	I/O-2	Description
1	Н	L	output	input	system-1 data to system-2
2	Η	Η	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Η	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	L	input	output	system-2 data to system-1

Table 16. Description bidirectional logic level-shifting application^[1]

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

13.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

Table 17.	Typical total supply current (I _{CC(A)} + I _{CC(B)})

V _{CC(A)}	V _{CC(B)}	V _{CC(B)}							
	0 V	1.8 V	2.5 V	3.3 V	5.0 V				
0 V	0	< 1	< 1	< 1	< 1	μA			
1.8 V	< 1	< 2	< 2	< 2	2	μΑ			
2.5 V	< 1	< 2	< 2	< 2	< 2	μΑ			
3.3 V	< 1	< 2	< 2	< 2	< 2	μΑ			
5.0 V	< 1	2	< 2	< 2	< 2	μΑ			

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14. Package outline

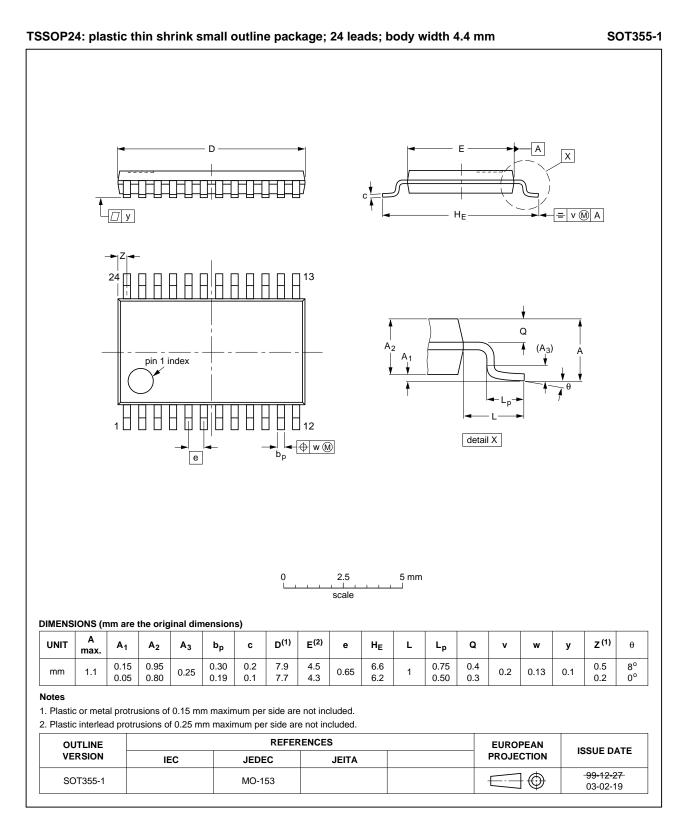
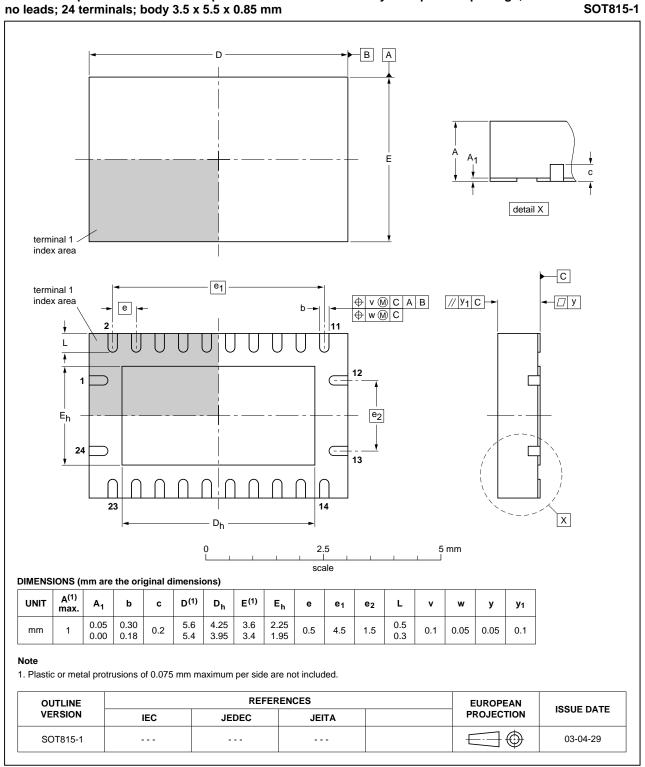


Fig 16. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 17. Package outline SOT815-1 (DHVQFN24)

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15. Abbreviations

Table 18.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
HBM	Human Body Model
MM	Machine Model

16. Revision history

Table 19. Revision	history
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Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC_LVCH8T245 v.2	20110211	Product data sheet	-	74LVC_LVCH8T245 v.1		
Modifications:	Modifications: Section 2 "Features and benefits" ESD performance added.					
74LVC_LVCH8T245 v.1	20100111	Product data sheet	-	-		

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17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Product data sheet

8-bit dual supply translating transceiver; 3-state

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